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MAX17126B

Multi-Output Power Supplies with VCOM Amplifier and High-Voltage Gamma Reference for LCD TVs

General Description

The MAX17126B generates all the supply rails for thin-film transistor liquid-crystal display (TFT LCD) TV panels operating from a regulated 12V input. They include a step-down and a step-up regulator, a positive and a negative charge pump, an operational amplifier, a high-accuracy high-voltage gamma reference, and a high-voltage switch control block. The device can operate from input voltages from 8V to 16.5V and is optimized for an LCD TV panel running directly from 12V supplies.

The step-up and step-down switching regulators feature internal power MOSFETs and high-frequency operation allowing the use of small inductors and capacitors, resulting in a compact solution. The step-up regulator provides TFT source driver supply voltage, while the step-down regulator provides the system with logic supply voltage. Both regulators use fixed-frequency current-mode control architectures, providing fast load-transient response and easy compensation. A current-limit function for internal switches and output-fault shutdown protects the step-up and step-down power supplies against fault conditions. The device provides soft-start functions to limit inrush current during startup. In addition, the device integrates a control block that can drive an external p-channel MOSFET to sequence power to source drivers.

The positive and negative charge-pump regulators provide TFT gate-driver supply voltages. Both output voltages can be adjusted with external resistive voltage-dividers. A logic-controlled, high-voltage switch block allows the manipulation of the positive gate-driver supply.

The device includes one high-current operational amplifier designed to drive the LCD backplane (VCOM). The amplifier features high output current ($\pm 200\text{mA}$), fast slew rate ($45\text{V}/\mu\text{s}$), wide bandwidth (20MHz), and rail-to-rail outputs.

Also featured in the device is a high-accuracy, high-voltage adjustable reference for gamma correction.

The device is available in a small (7mm x 7mm), ultra-thin (0.8mm), 48-pin TQFN package and operates over the -40°C to $+85^\circ\text{C}$ temperature range.

Applications

LCD TV Panels

Visit www.maximintegrated.com/products/patents for product patent marking information.

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maximintegrated.com.

Features

- ◆ 8.0V to 16.5V IN Supply Voltage Range
- ◆ Selectable Frequency (500kHz/750kHz)
- ◆ Current-Mode Step-Up Regulator
 - Fast Load-Transient Response
 - High-Accuracy Output Voltage (1.0%)
 - Built-In 20V, 3.5A, 100m Ω MOSFET
 - High Efficiency
 - Adjustable Soft-Start
 - Adjustable Current Limit
 - Low Duty-Cycle Operation (13.2VIN - 13.5V AVDD)
- ◆ Current-Mode Step-Down Regulator
 - Fast Load-Transient Response
 - Built-In 20V, 3.2A, 100m Ω MOSFET
 - High Efficiency
 - 3ms Internal Soft-Start
- ◆ Adjustable Positive Charge-Pump Regulator
- ◆ Adjustable Negative Charge-Pump Regulator
- ◆ Integrated High-Voltage Switch with Adjustable Turn-On Delay
- ◆ High-Speed Operational Amplifier
 - $\pm 200\text{mA}$ Short-Circuit Current
 - 45V/ μs Slew Rate
- ◆ High-Accuracy Reference for Gamma Buffer
 - $\pm 1\%$ Feedback Voltage
 - Up to 30mA Load Current
 - Low-Dropout Voltage 0.5V at 60mA
- ◆ External p-Channel Gate Control for AVDD Sequencing
- ◆ XAO Comparator
- ◆ Input Undervoltage Lockout and Thermal-Overload Protection
- ◆ 48-Pin, 7mm x 7mm, TQFN Package

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX17126BETM+	-40°C to $+85^\circ\text{C}$	48 TQFN-EP*

+ Denotes a lead(Pb)-free/RoHS-compliant package.

*EP = Exposed pad.

MAX17126B

Multi-Output Power Supplies with VCOM Amplifier and High-Voltage Gamma Reference for LCD TVs

ABSOLUTE MAXIMUM RATINGS

INVL, IN2, VOP, EN, FSEL to GND	-0.3V to +24V
PGND, OGND, CPGND to GND	-0.3V to +0.3V
DLY1, GVOFF, THR, VL to GND	-0.3V to +7.5V
REF, FBP, FBN, FB1, FB2, COMP, SS, CLIM, XAO, VDET, VREF_FB, OUT to GND	-0.3V, (VL + 0.3)
GD, GD_I to GND	-0.3V to +24V
LX1 to PGND	-0.3V to +24V
OPP, OPN, OPO to OGND	-0.3V to (VOP + 0.3V)
DRVN to CPGND	-0.3V to (SUPP + 0.3V)
DRVN to CPGND	-0.3V to (SUPN + 0.3V)
LX2 to PGND	-0.7 to (IN2 + 0.3V)
SUPN to GND	-0.3V to (IN2 + 0.3V)
SUPP to GND	-0.3V to (GD_I + 0.3V)
BST to VL	-0.3V to +30V
VGH to GND	-0.3V to +40V
VGHM, DRN to GND	-0.3V, VGH + 0.3V
VGHM to DRN	-0.3V to +40V

VREF_I to GND	-0.3V to +24V
VREF_O to GND	-0.3V, (VREF_I + 0.3)V
REF Short Circuit to GND	Continuous
RMS LX1 Current (total for both pins)	3.2A
RMS PGND CURRENT (total for both pins)	3.2A
RMS IN2 Current (total for both pins)	3.2A
RMS LX2 Current (total for both pins)	3.2A
RMS DRVN, DRVN Current	0.8A
RMS VL Current	50mA
Continuous Power Dissipation (TA = +70°C)	
TQFN (derated 38.5mW/°C above +70°C)	3076.9mW
Junction Temperature	+160°C
Storage Temperature Range	-65°C to +165°C
Lead Temperature (soldering, 10s)	+300°C
Soldering Temperature (reflow)	+260°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(Circuit of Figure 1, VINVL = VIN2 = 12V, VVOP = VVREF_I = 15V, TA = 0°C to +85°C. Typical values are at TA = +25°C, unless otherwise noted.)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
GENERAL					
INVL, IN2 Input Voltage Range		8		16.5	V
INVL + IN2 Quiescent Current	Only LX2 switching (VFB1 = VFBN = 1.5V, VFBN = 0V) EN = VL, FSEL = high		10	20	mA
INVL + IN2 Standby Current	LX2 not switching (VFB1 = VFBN = 1.5V, VFBN = 0V), EN = VL, FSEL = high		24	5	mA
SMPS Operating Frequency	FSEL = INVL or high impedance	630	750	870	kHz
	FSEL = GND	420	500	580	
INVL Undervoltage-Lockout Threshold	INVL rising, 150mV typical hysteresis	6.0	7.0	8.0	V
VL REGULATOR					
VL Output Voltage	I _{VL} = 25mA, VFB1 = VFBN = VFBN = 1.1V, VFBN = 0.4V (all regulators switching)	4.85	5	5.15	V
VL Undervoltage-Lockout Threshold	VL rising, 50mV typical hysteresis	3.5	3.9	4.3	V
REFERENCE					
REF Output Voltage	No external load	1.2375	1.250	1.2625	V
REF Load Regulation	0V < I _{LOAD} < 50μA			5	mV
REF Sink Current	In regulation	10			μA
REF Undervoltage-Lockout Threshold	Rising edge, 250mV typical hysteresis		1.0	1.2	V

MAX17126B

Multi-Output Power Supplies with VCOM Amplifier and High-Voltage Gamma Reference for LCD TVs

ELECTRICAL CHARACTERISTICS (continued)

(Circuit of Figure 1, $V_{INVL} = V_{IN2} = 12V$, $V_{VOP} = V_{VREF_I} = 15V$, $T_A = 0^\circ C$ to $+85^\circ C$. Typical values are at $T_A = +25^\circ C$, unless otherwise noted.)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
STEP-DOWN REGULATOR						
OUT Voltage in Fixed Mode	FB2 = GND, no load (Note 1)	$0^\circ C < T_A = +85^\circ C$	3.25	3.3	3.35	V
		$T_A = +25^\circ C$	3.267		3.333	
FB2 Voltage in Adjustable Mode	$V_{OUT} = 2.5V$, no load (Note 1)	$0^\circ C < T_A = +85^\circ C$	1.23	1.25	1.27	V
		$T_A = +25^\circ C$	1.2375		1.2625	
FB2 Adjustable Mode Threshold Voltage	Dual Mode™ comparator	0.10	0.15	0.20	V	
Output Voltage Adjust Range		1.5		5	V	
FB2 Fault-Trip Level	Falling edge	0.96	1.0	1.04	V	
FB2 Input Leakage Current	$V_{FB2} = 1.25V$	50	125	200	nA	
DC Load Regulation	$0V < I_{LOAD} < 2A$		0.5		%	
DC Line Regulation	No load, $10.8V < V_{IN2} < 13.2V$		0.1		%/V	
LX2-to-IN2 nMOS Switch On-Resistance			100	200	mΩ	
LX2-to-GND2 nMOS Switch On-Resistance		6	10	23	Ω	
BST-to-VL pMOS Switch On-Resistance		40	30	110	Ω	
Low-Frequency Operation OUT Threshold	LX2 only		0.8		V	
Low-Frequency Operation Switching Frequency	FSEL = INVL		125		kHz	
	FSEL = GND		83			
LX2 Positive Current Limit	MAX17126	2.50	3.20	3.90	A	
Soft-Start Ramp Time	Zero to full limit		3		ms	
Maximum Duty Factor		70	78	85	%	
Minimum Duty Factor Char/Design Limit Only				10	%	
STEP-UP REGULATOR						
Output Voltage Range		V_{IN}		20	V	
Oscillator Maximum Duty Cycle		70	78	85	%	
FB1 Regulation Voltage	FB1 = COMP, $C_{COMP} = 1nF$	1.2375	1.25	1.2625	V	
FB1 Fault Trip Level	Falling edge	0.96	1.0	1.04	V	
FB1 Load Regulation	$0V < I_{LOAD} < full$		0.5		%	
FB1 Line Regulation	$10.8V < V_{IN} < 13.2V$		0.08		%/V	
FB1 Input Bias Current	$V_{FB1} = 1.25V$	30	125	200	nA	
FB1 Transconductance	$\Delta I = \pm 2.5\mu A$ at COMP, FB1 = COMP	150	320	560	μS	
FB1 Voltage Gain	FB1 to COMP		1400		V/V	
LX1 Leakage Current	$V_{FB1} = 1.5V$, $V_{LX1} = 20V$		10	40	μA	

Dual Mode is a trademark of Maxim Integrated Products, Inc.

MAX17126B

Multi-Output Power Supplies with VCOM Amplifier and High-Voltage Gamma Reference for LCD TVs

ELECTRICAL CHARACTERISTICS (continued)

(Circuit of Figure 1, $V_{INVL} = V_{IN2} = 12V$, $V_{VOP} = V_{VREF_I} = 15V$, $T_A = 0^\circ C$ to $+85^\circ C$. Typical values are at $T_A = +25^\circ C$, unless otherwise noted.)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
LX1 Current Limit	$V_{FB1} = 1.1V$, $R_{CLIM} = \text{unconnected}$	3.0	3.5	4.2	A
	$V_{FB1} = 1.1V$, with R_{CLIM} at CLIM pin	-20%	3.5 - (68k/ R_{CLIM})	+20%	
CLIM Voltage	$R_{CLIM} = 60.5k\Omega$	0.56	0.625	0.69	V
Current-Sense Transresistance		0.19	0.21	0.25	V/A
LX1 On-Resistance			100	185	m Ω
Soft-Start Period	$C_{SS} < 200pF$		16		ms
SS Charge Current	$V_{SS} = 1.2V$	4	5	6	μA
POSITIVE CHARGE-PUMP REGULATORS					
GD_I Input Supply Range		8.0		20	V
GD_I Input Supply Current	$V_{FBP} = 1.5V$ (not switching)		0.15	0.3	mA
GD_I Overvoltage Threshold	GD_I rising, 250mV typical hysteresis (Note 2)	20.1	21	22	V
FBP Regulation Voltage		1.2375	1.25	1.2625	V
FBP Line Regulation Error	$V_{SUP} = 11V$ to 16V, not in dropout			0.2	%/V
FBP Input Bias Current	$V_{FBP} = 1.5V$, $T_A = +25^\circ C$	-50		+50	nA
DRV_P p-Channel MOSFET On-Resistance			1.5	3	Ω
DRV_P n-Channel MOSFET On-Resistance			1	2	Ω
FBP Fault Trip Level	Falling edge	0.96	1.0	1.04	V
Positive Charge-Pump Soft-Start Period	7-bit voltage ramp with filtering to prevent high peak currents 500kHz frequency		4		ms
	750kHz frequency		3		ms
NEGATIVE CHARGE-PUMP REGULATORS					
FBN Regulation Voltage	$V_{REF} - V_{FBN}$	0.99	1.00	1.01	V
FBN Input Bias Current	$V_{FBN} = 0mV$, $T_A = +25^\circ C$	-50		+50	nA
FBN Line Regulation Error	$V_{IN2} = 11V$ to 16V, not in dropout			0.2	%/V
DRV_N PCH On-Resistance			1.5	3	Ω
DRV_N NCH On-Resistance			1	2	Ω
FBN Fault Trip Level	Rising edge	720	800	880	mV
Negative Charge-Pump Soft-Start Period	7-bit voltage ramp with filtering to prevent high peak currents 500kHz frequency		3		ms
	750kHz frequency		2		
AVDD SWITCH GATE CONTROL					
GD to GD_I Pullup Resistance	EN = GND		25	50	Ω
GD Output Sink Current	EN = VL	5	10	15	μA
GD Done Threshold	EN = VL, $V_{GD_I} - V_{GD}$	5	6	7	V
OPERATIONAL AMPLIFIERS					
VOP Supply Range		8		20	V

Multi-Output Power Supplies with VCOM Amplifier and High-Voltage Gamma Reference for LCD TVs

ELECTRICAL CHARACTERISTICS (continued)

(Circuit of Figure 1, $V_{INVL} = V_{IN2} = 12V$, $V_{VOP} = V_{VREF_I} = 15V$, $T_A = 0^\circ C$ to $+85^\circ C$. Typical values are at $T_A = +25^\circ C$, unless otherwise noted.)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
VOP Overvoltage Fault Threshold	$V_{VOP} = \text{rising}$, hysteresis = 200mV (Note 2)	20.1	21	22	V
VOP Supply Current	Buffer configuration, $V_{OPP} = V_{OPN} = V_{VOP}/2$, no load	-10	-2	+6	mA
Input Offset Voltage	$2V < (V_{OPP}, V_{OPN}) < (V_{VOP} - 2V)$		3	14	mV
Input Bias Current	$2V < (V_{OPP}, V_{OPN}) < (V_{VOP} - 2V)$	-1		+1	μA
Input Common-Mode Voltage Range		0		VOP	V
Input Common-Mode Rejection Ratio	$2V < (V_{OPP}, V_{OPN}) < (V_{VOP} - 2V)$		80		dB
Output Voltage Swing High	$I_{OPO} = 25mA$	$V_{VOP} - 320$	$V_{VOP} - 150$		mV
Output Voltage Swing Low	$I_{OPO} = -25mA$		150	300	mV
Large-Signal Voltage Gain	$2V < (V_{OPP}, V_{OPN}) < (V_{VOP} - 2V)$		80		dB
Slew Rate	$2V < (V_{OPP}, V_{OPN}) < (V_{VOP} - 2V)$		45		V/ μs
-3dB Bandwidth	$2V < (V_{OPP}, V_{OPN}) < (V_{VOP} - 2V)$		20		MHz
Short-Circuit Current	Short to $V_{VOP}/2$, sourcing	200			mA
	Short to $V_{VOP}/2$, sinking	200			
HIGH-VOLTAGE SWITCH ARRAY					
VGH Supply Range				35	V
VGH Supply Current			150	300	μA
VGHM-to-VGH Switch On-Resistance	$V_{DLY1} = 2V$, $GVOFF = VL$		5	10	Ω
VGHM-to-VGH Switch Saturation Current	$V_{VGH} - V_{VGHM} > 5V$	150	390		mA
VGHM-to-DRN Switch On-Resistance	$V_{DLY1} = 2V$, $GVOFF = GND$		20	50	Ω
VGHM-to-DRN Switch Saturation Current	$V_{VGHM} - V_{DRN} > 5V$	75	200		mA
VGHM-to-GND Switch On-Resistance	$DLY1 = GND$	1.0	2.5	4.0	k Ω
GVOFF Input Low Voltage				0.6	V
GVOFF Input High Voltage		1.6			V
GVOFF Input Current	$V_{GVOFF} = 0V$ or VL , $T_A = +25^\circ C$	-1		+1	μA
GVOFF-to-VGHM Rising Propagation Delay	1k Ω from DRN to CPGND, $V_{GVOFF} = 0V$ to VL step, no load on VGHM, measured from $GVOFF = 2V$ to $VGHM = 20\%$		100		ns
GVOFF-to-VGHM Falling Propagation Delay	1k Ω from DRN to CPGND, $V_{GVOFF} = VL$ to $0V$ step, no load on VGHM, DRN falling, no load on DRN and VGHM, measured from $V_{GVOFF} = 0.6V$ to $VGHM = 80\%$		200		ns
THR-to-VGHM Voltage Gain		9.4	10	10.6	V/V

MAX17126B

Multi-Output Power Supplies with VCOM Amplifier and High-Voltage Gamma Reference for LCD TVs

ELECTRICAL CHARACTERISTICS (continued)

(Circuit of Figure 1, $V_{INVL} = V_{IN2} = 12V$, $V_{VOP} = V_{VREF_I} = 15V$, $T_A = 0^\circ C$ to $+85^\circ C$. Typical values are at $T_A = +25^\circ C$, unless otherwise noted.)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
SEQUENCE CONTROL					
EN Pulldown Resistance			1		M Ω
DLY1 Charge Current	$V_{DLY1} = 1V$; when DLY1 cap is not used, there is no delay	6	8	10	μA
EN, DLY1 Turn-On Threshold		1.19	1.25	1.31	V
DLY1 Discharge Switch On-Resistance	EN = GND or fault tripped		10		Ω
FBN Discharge Switch On-Resistance	(EN = GND and INVL < UVLO) or fault tripped		3		k Ω
GAMMA REFERENCE					
VREF_I Input Voltage Range		10		18.0	V
VREF_I Input Bias Current	No load		125	250	μA
VREF_O Dropout Voltage	$I_{VREF_O} = 60mA$		0.25	0.5	V
VREF_FB Regulation Voltage	$V_{VREF_I} = 13.5V$, $1mA \leq I_{VREF_O} \leq 30mA$, $V_{VREF_O} = 9.5V$	1.243	1.250	1.256	V
	V_{VREF_I} from 10V to 18V, $I_{VREF_O} = 20mA$, $V_{VREF_O} = 9.5V$			≤ 0.9	mV/V
VREF_O Maximum Output Current		60			mA
XAO FUNCTION					
VDET Threshold	VDET rising	1.225	1.25	1.275	V
VDET Hysteresis			50		mV
VDET Input Bias Current		50	175	300	nA
XAO Output Voltage	VDET = AGND, $I_{PGOOD} = 1mA$			0.4	V
FAULT DETECTION					
Duration-to-Trigger Fault	For UVP only		50		ms
Step-Up Short-Circuit Protection	FB1 falling edge	$0.36 \times V_{REF}$	$0.4 \times V_{REF}$	$0.44 \times V_{REF}$	V
Step-Down Short-Circuit Protection	Adjustable mode FB2 falling	$0.18 \times V_{REF}$	$0.2 \times V_{REF}$	$0.22 \times V_{REF}$	V
	Fixed mode OUT falling, internal feedback divider voltage	$0.18 \times V_{REF}$	$0.2 \times V_{REF}$	$0.22 \times V_{REF}$	
Positive Charge-Pump Short-Circuit Protection	FBP falling edge	$0.36 \times V_{REF}$	$0.4 \times V_{REF}$	$0.44 \times V_{REF}$	V
Negative Charge-Pump Short-Circuit Protection	$V_{REF} - V_{FBN}$	0.4	0.45	0.5	V
Thermal-Shutdown Threshold	Latch protection		+160		$^\circ C$
SWITCHING FREQUENCY SELECTION					
FSEL Input Low Voltage	500kHz			0.6	V
FSEL Input High Voltage	750kHz	1.6			V
FSEL Pullup Resistance			1		M Ω

MAX17126B

Multi-Output Power Supplies with VCOM Amplifier and High-Voltage Gamma Reference for LCD TVs

ELECTRICAL CHARACTERISTICS

($V_{INVL} = V_{IN2} = 12V$, $V_{VOP} = V_{VREF_I} = 15V$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$.) (Note 3)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
GENERAL					
INVL, IN2 Input-Voltage Range		8		16.5	V
SMPS Operating Frequency	FSEL = INVL or high impedance	630		870	kHz
	FSEL = GND	420		580	
INVL Undervoltage-Lockout Threshold	INVL rising, 150mV typical hysteresis	6.0		8.0	V
VL REGULATOR					
VL Output Voltage	$I_L = 25mA$, $V_{FB1} = V_{FB2} = V_{FB} = 1.1V$, $V_{FBN} = 0.4V$ (all regulators switching)	4.85		5.15	V
VL Undervoltage-Lockout Threshold	VL rising, 50mV typical hysteresis	3.5		4.3	V
REFERENCE					
REF Output Voltage	No external load	1.235		1.265	V
REF Undervoltage-Lockout Threshold	Rising edge, 25mV typical hysteresis			1.2	V
STEP-DOWN REGULATOR					
OUT Voltage in Fixed Mode	FB2 = GND, no load (Note 1)	3.267		3.333	V
FB2 Voltage in Adjustable Mode	$V_{OUT} = 2.5V$, no load (Note 1)	1.2375		1.2625	V
FB2 Adjustable Mode Threshold Voltage	Dual-mode comparator	0.10		0.20	V
Output Voltage Adjust Range		1.5		5	V
FB2 Fault Trip Level	Falling edge	0.96		1.04	V
LX2-to-IN2 nMOS Switch On-Resistance				200	m Ω
LX2-to-GND2 nMOS Switch On-Resistance		6		23	Ω
BST-to-VL pMOS Switch On-Resistance		40		110	Ω
LX2 Positive Current Limit	MAX17126	2.50		3.90	A
Maximum Duty Factor		70		85	%

MAX17126B

Multi-Output Power Supplies with VCOM Amplifier and High-Voltage Gamma Reference for LCD TVs

ELECTRICAL CHARACTERISTICS (continued)

($V_{INVL} = V_{IN2} = 12V$, $V_{VOP} = V_{VREF_I} = 15V$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$.) (Note 3)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
STEP-UP REGULATOR					
Output-Voltage Range		V_{IN}		20	V
Oscillator Maximum Duty Cycle		70		85	%
FB1 Regulation Voltage	FB1 = COMP, $C_{COMP} = 1nF$	1.2375		1.2625	V
FB1 Fault Trip Level	Falling edge	0.96		1.04	V
FB1 Transconductance	$\Delta I = \pm 2.5\mu A$ at COMP, FB1 = COMP	150		560	μS
LX1 Input Bias Current	$V_{FB1} = 1.5V$, $V_{LX1} = 20V$			40	μA
LX1 Current Limit	$V_{FB1} = 1.1V$, $R_{CLIM} =$ unconnected	3.0		4.2	A
	$V_{FB1} = 1.1V$, with R_{CLIM} at CLIM pin, limit = $3.5A - (68k\Omega/R_{CLIM})$	-20%		+20%	
CLIM Voltage	$R_{CLIM} = 60.5k\Omega$	0.56		0.69	V
Current-Sense Transresistance		0.19		0.25	V/A
LX1 On-Resistance				185	$m\Omega$
SS Charge Current	$V_{SS} = 1.2V$	4		6	μA
POSITIVE CHARGE-PUMP REGULATORS					
GD_I Input Supply Range		8.0		20	V
GD_I Input Supply Current	$V_{FBP} = 1.5V$ (not switching)			0.2	mA
GD_I Overvoltage Threshold	GD_I rising, 250mV typical hysteresis (Note 2)	20.1		22	V
FBP Regulation Voltage		1.243		1.256	V
FBP Line Regulation Error	$V_{SUP} = 11V$ to $16V$, not in dropout			0.2	%/V
DRV_P p-Channel MOSFET On-Resistance				3	Ω
DRV_N n-Channel MOSFET On-Resistance				1	Ω
FBP Fault Trip Level	Falling edge	0.96		1.04	V
NEGATIVE CHARGE-PUMP REGULATORS					
FBN Regulation Voltage	$V_{REF} - V_{FBN}$	0.99		1.01	V
FBN Line Regulation Error	$V_{IN2} = 11V$ to $16V$, not in dropout			0.2	%/V
DRVN_PCH On-Resistance				3	Ω
DRVN_NCH On-Resistance				1	Ω
FBN Fault Trip Level	Rising edge	720		880	mV
AVDD SWITCH GATE CONTROL					
GD Output Sink Current	EN = VL	5		15	μA
GD Done Threshold	EN = VL, $V_{GD_I} - V_{GD}$	5		7	V

MAX17126B

Multi-Output Power Supplies with VCOM Amplifier and High-Voltage Gamma Reference for LCD TVs

ELECTRICAL CHARACTERISTICS (continued)

($V_{INVL} = V_{IN2} = 12V$, $V_{VOP} = V_{VREF_1} = 15V$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$.) (Note 3)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
OPERATIONAL AMPLIFIERS					
VOP Supply Range		8		20	V
VOP Overvoltage Fault Threshold	VOP = rising, hysteresis = 200mV (Note 2)	20.1		22	V
VOP Supply Current	Buffer configuration, $V_{OPP} = V_{OPN} = V_{OP}/2$, no load			4	mA
Input Offset Voltage	$2V < (V_{OPP}, V_{OPN}) < (V_{OP} - 2V)$	-12		+8	mV
Input Common-Mode Voltage Range		0		OVIN	V
Output Voltage Swing High	$I_{OPO} = 25mA$	VOP - 320			mV
Output Voltage Swing Low	$I_{OPO} = -25mA$			300	mV
Short-Circuit Current	Short to $V_{OPO}/2$, sourcing	200			mA
	Short to $V_{OPO}/2$, sinking	200			
HIGH-VOLTAGE SWITCH ARRAY					
VGH Supply Range				35	V
VGH Supply Current				300	μA
VGHM-to-VGH Switch On-Resistance	$V_{DLY1} = 2V$, $GVOFF = VL$			10	Ω
VGHM-to-VGH Switch Saturation Current	$V_{VGH} - V_{VGHM} > 5V$	150			mA
VGHM-to-DRN Switch On-Resistance	$V_{DLY1} = 2V$, $GVOFF = GND$			50	Ω
VGHM-to-DRN Switch Saturation Current	$V_{VGHM} - V_{DRN} > 5V$	75			mA
VGHM-to-GND Switch On-Resistance	$DLY1 = GND$	1.0		4.0	k Ω
GVOFF Input Low Voltage				0.6	V
GVOFF Input High Voltage		1.6			V
THR-to-VGHM Voltage Gain		9.4		10.6	V/V
SEQUENCE CONTROL					
EN Input Low Voltage				0.6	V
EN Input High Voltage		1.6			V
DLY1 Charge Current	$V_{DLY1} = 1V$; when DLY1 cap is not used, there is no delay	6		10	μA
DLY1 Turn-On Threshold		1.19		1.31	V

MAX17126B

Multi-Output Power Supplies with VCOM Amplifier and High-Voltage Gamma Reference for LCD TVs

ELECTRICAL CHARACTERISTICS (continued)

($V_{INVL} = V_{IN2} = 12V$, $V_{VOP} = V_{VREF_I} = 15V$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$.) (Note 3)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
GAMMA REFERENCE					
VREF_I Input Voltage Range		10		18.0	V
VREF_I Undervoltage Lockout	VREF_I rising			5.2	V
VREF_I Input Bias Current	No load			250	μA
VREF_O Dropout Voltage	$I_{VREF_O} = 60mA$			0.5	V
VREF_FB Regulation Voltage	$V_{REF_I} = 13.5V$, $1mA \leq I_{VREF_O} \leq 30mA$	1.2375		1.2625	V
	V_{REF_I} from 10V to 18V, $I_{VREF_O} = 20mA$			≤ 0.9	mV/V
VREF_O Maximum Output Current		60			mA
XAO FUNCTION					
VDET Threshold	VDET rising	1.225		1.275	V
XAO Output Voltage	$V_{DET} = AGND$, $I_{PGOOD} = 1mA$			0.4	V
FAULT DETECTION					
Step-Up Short-Circuit Protection	FB1 falling edge	$0.36 \times V_{REF}$		$0.44 \times V_{REF}$	V
Step-Down Short-Circuit Protection	Adjustable mode FB2 falling	$0.18 \times V_{REF}$		$0.22 \times V_{REF}$	V
	Fixed mode OUT falling, internal feedback divider voltage	$0.18 \times V_{REF}$		$0.22 \times V_{REF}$	V
Positive Charge-Pump Short-Circuit Protection	FBP falling edge	$0.36 \times V_{REF}$		$0.44 \times V_{REF}$	V
Negative Charge-Pump Short-Circuit Protection	$V_{REF} - V_{FBN}$	0.4		0.5	V
SWITCHING FREQUENCY SELECTION					
FSEL Input Low Voltage	500kHz			0.6	V
FSEL Input High Voltage	750kHz	1.6			V

Note 1: When the step-down inductor is in continuous conduction ($EN = VL$ or heavy load), the output voltage has a DC regulation level lower than the error comparator threshold by 50% of the output voltage ripple. In discontinuous conduction ($EN = GND$ with light load), the output voltage has a DC regulation level higher than the error comparator threshold by 50% of the output voltage ripple.

Note 2: Disables boost switching if either GD_I or VOP exceeds the threshold. Switching resumes when no threshold is exceeded.

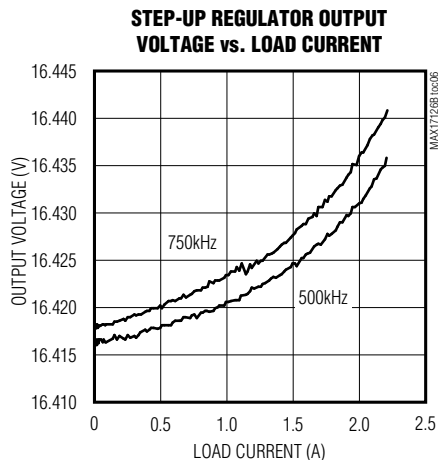
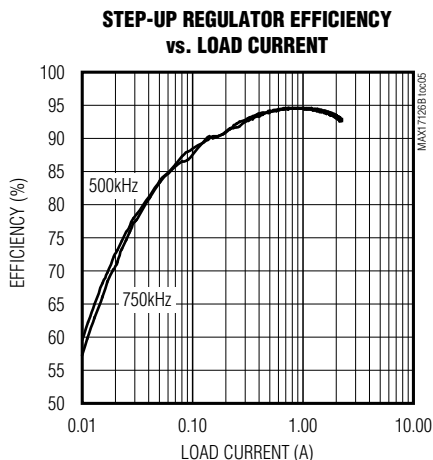
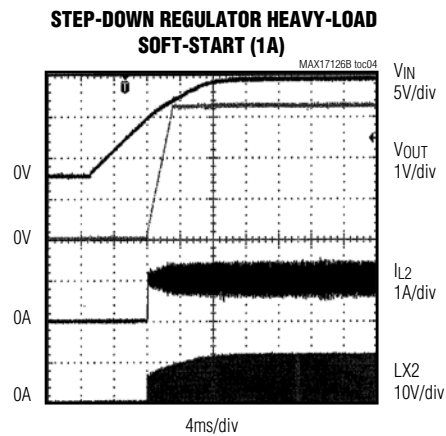
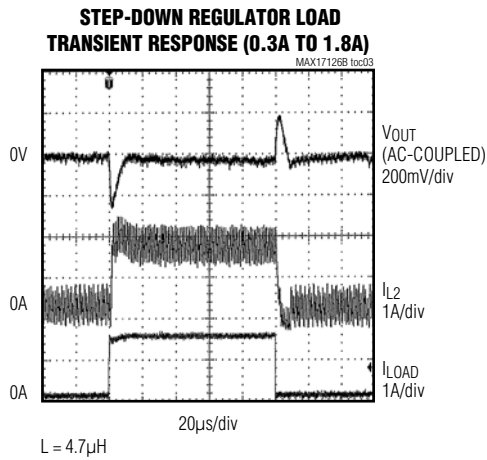
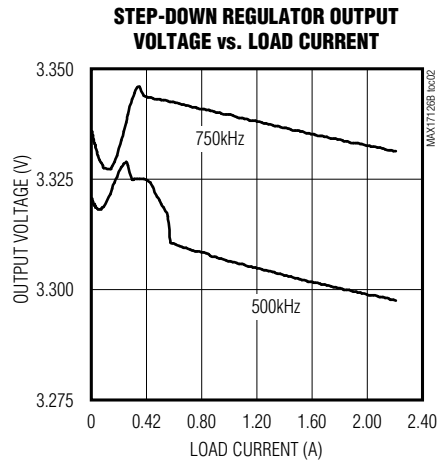
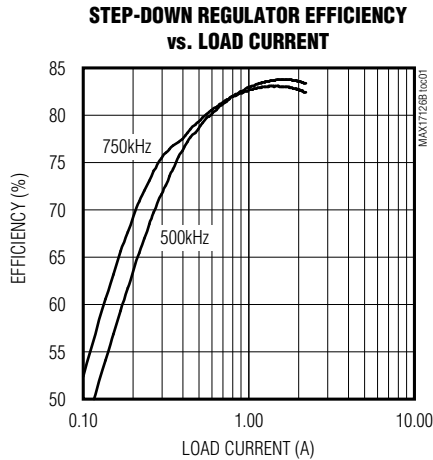
Note 3: Specifications to $T_A = -40^{\circ}C$ are guaranteed by design, not production tested.

MAX17126B

Multi-Output Power Supplies with VCOM Amplifier and High-Voltage Gamma Reference for LCD TVs

Typical Operating Characteristics

($T_A = +25^\circ\text{C}$, unless otherwise noted.)



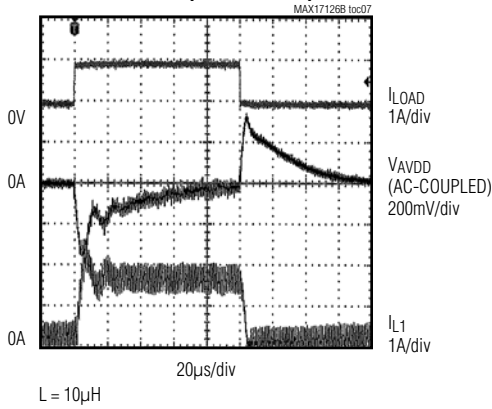
MAX17126B

Multi-Output Power Supplies with VCOM Amplifier and High-Voltage Gamma Reference for LCD TVs

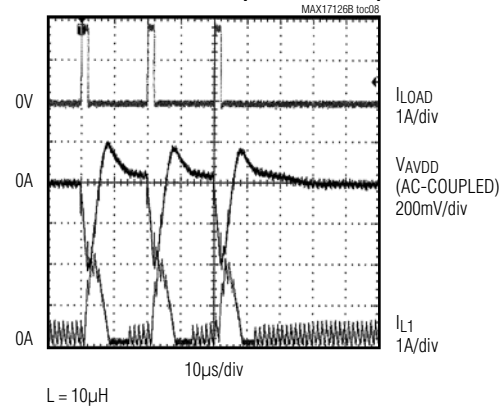
Typical Operating Characteristics (continued)

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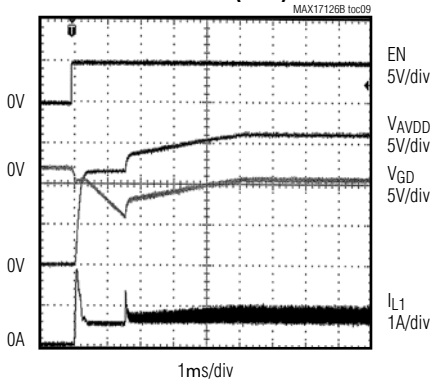
STEP-UP REGULATOR LOAD TRANSIENT RESPONSE (0.1A TO 1.1A)



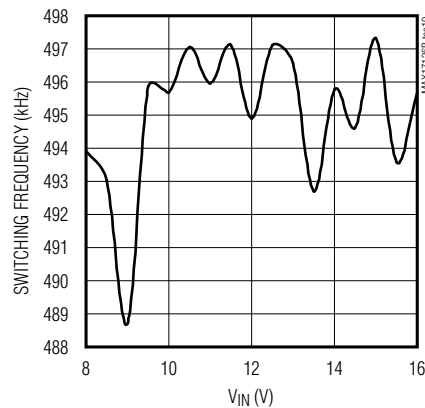
STEP-UP REGULATOR PULSED LOAD TRANSIENT RESPONSE (0.1A TO 1.9mA)



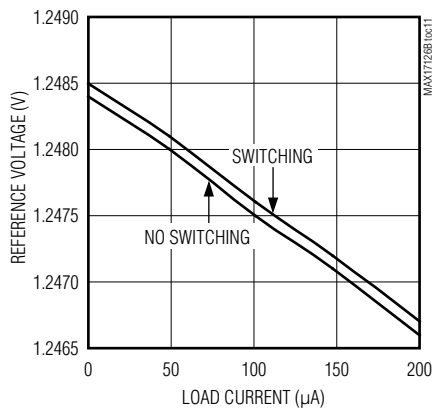
STEP-UP REGULATOR HEAVY LOAD SOFT-START (0.5A)



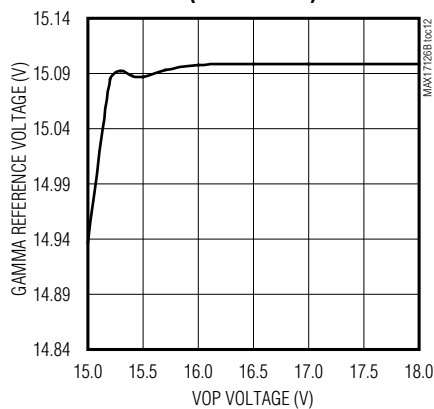
SWITCHING FREQUENCY vs. INPUT VOLTAGE



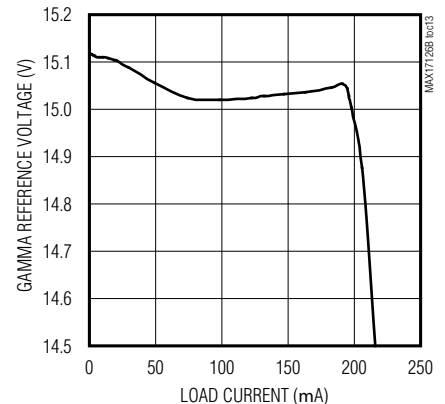
REFERENCE VOLTAGE LOAD REGULATION



GAMMA REFERENCE LINE REGULATION (LOAD = 20mA)



GAMMA REFERENCE LOAD REGULATION ($V_{REF} = 16\text{V}$)

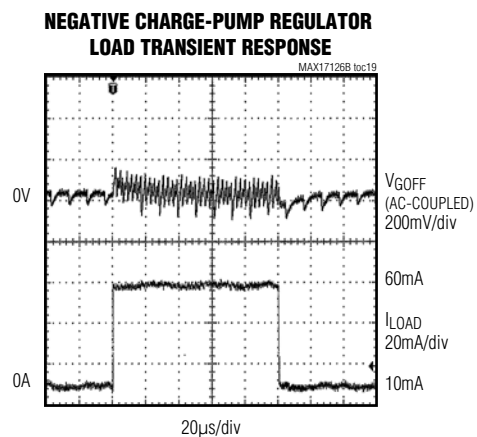
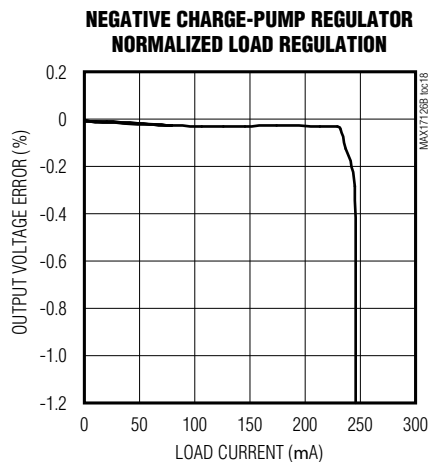
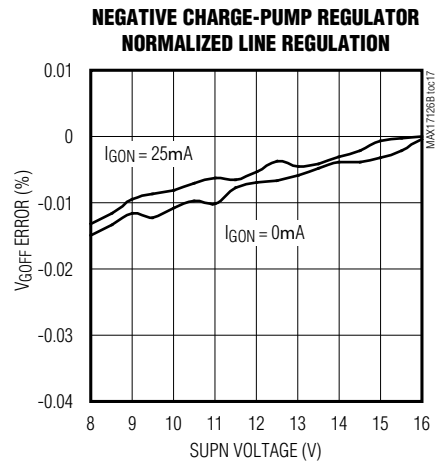
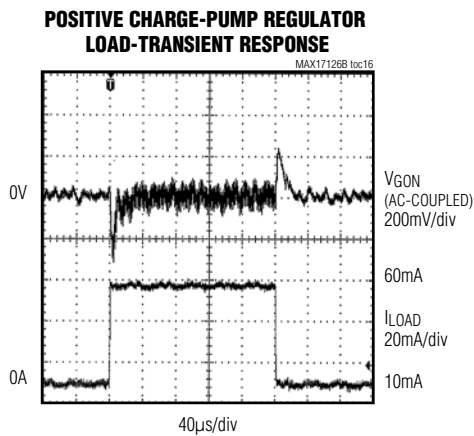
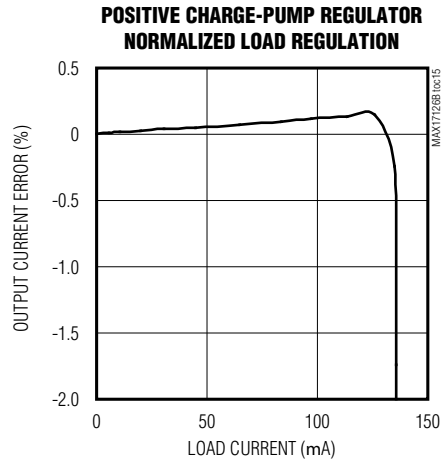
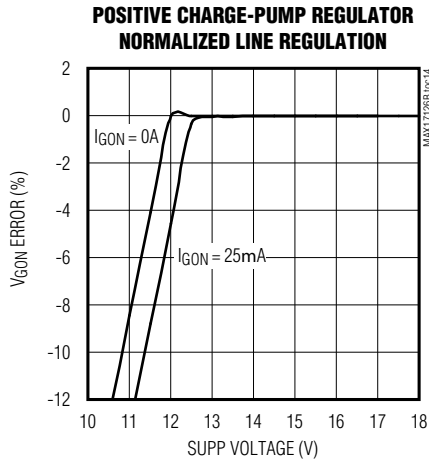


MAX17126B

Multi-Output Power Supplies with VCOM Amplifier and High-Voltage Gamma Reference for LCD TVs

Typical Operating Characteristics (continued)

($T_A = +25^\circ\text{C}$, unless otherwise noted.)

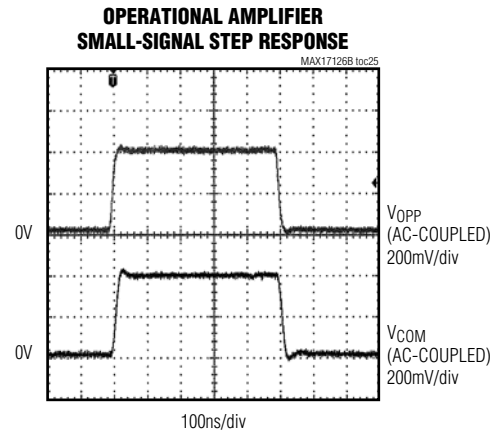
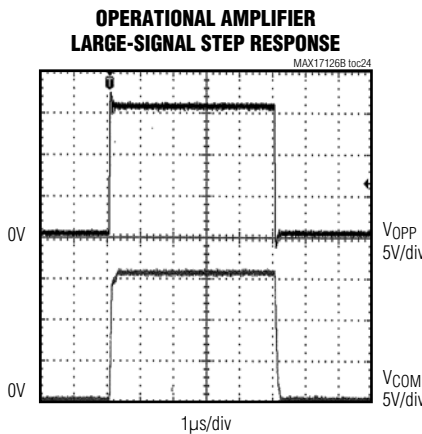
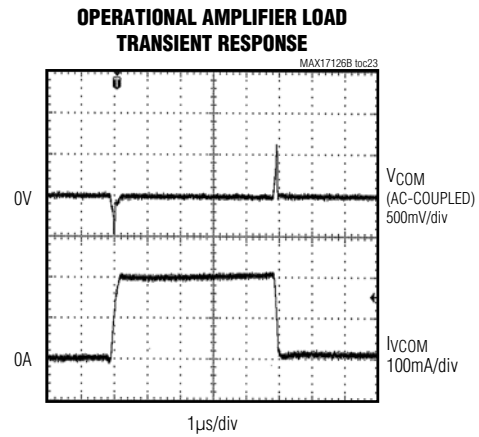
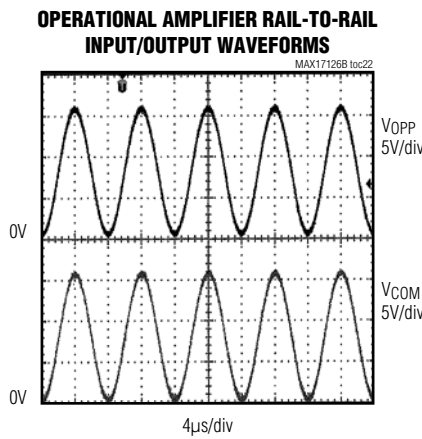
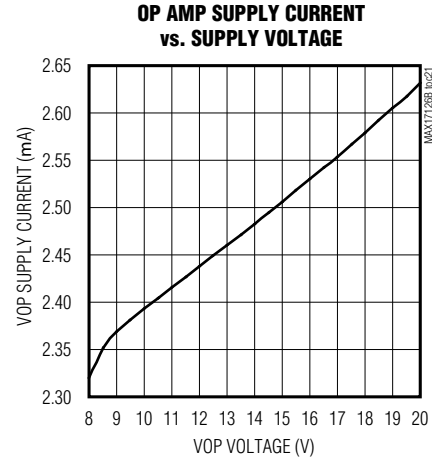
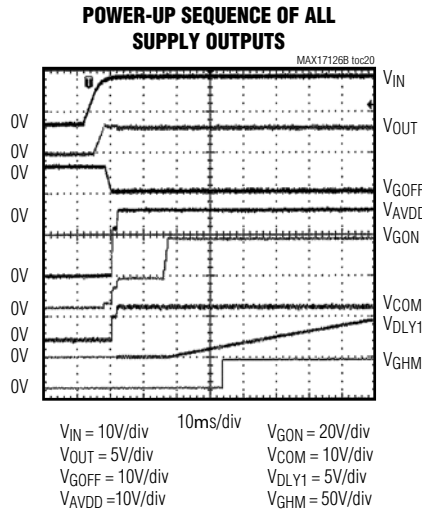


MAX17126B

Multi-Output Power Supplies with VCOM Amplifier and High-Voltage Gamma Reference for LCD TVs

Typical Operating Characteristics (continued)

($T_A = +25^\circ\text{C}$, unless otherwise noted.)

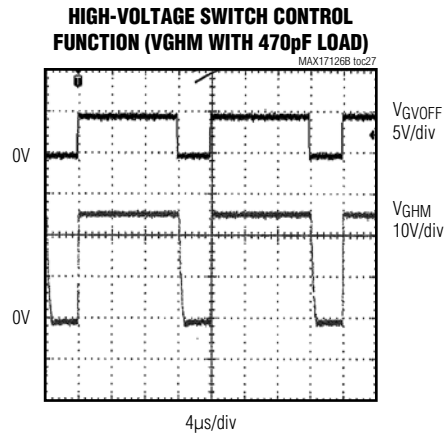
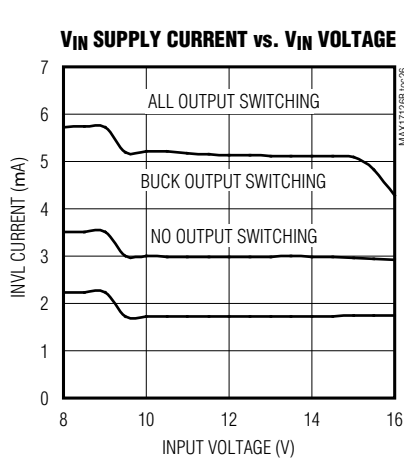


MAX17126B

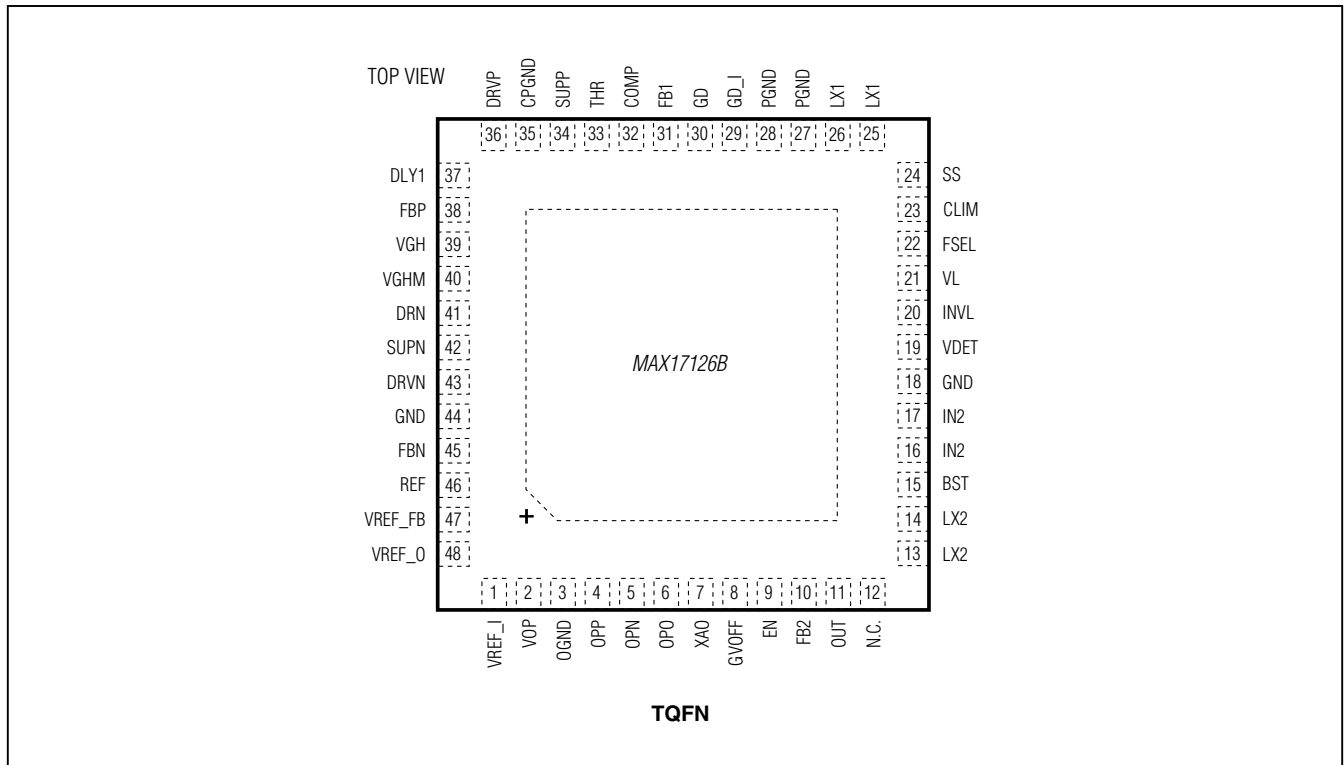
Multi-Output Power Supplies with VCOM Amplifier and High-Voltage Gamma Reference for LCD TVs

Typical Operating Characteristics (continued)

($T_A = +25^\circ\text{C}$, unless otherwise noted.)



Pin Configuration



MAX17126B

Multi-Output Power Supplies with VCOM Amplifier and High-Voltage Gamma Reference for LCD TVs

Pin Description

PIN	NAME	FUNCTION
1	VREF_I	Gamma Reference Input
2	VOP	Operational Amplifier Power Supply
3	OGND	Operational Amplifier Power Ground
4	OPP	Operational Amplifier Noninverting Input
5	OPN	Operational Amplifier Inverting Input
6	OPO	Operational Amplifier Output
7	XAO	Voltage Detector Output
8	GVOFF	High-Voltage Switch-Control Block Timing Control Input. See the <i>High-Voltage Switch Control</i> section for details.
9	EN	Enable Input. Enable is high, turns on step-up converter and positive charge pump.
10	FB2	Step-Down Regulator Feedback Input. Connect FB2 to GND to select the step-down converter's 3.3V fixed mode. For adjustable mode, connect FB2 to the center of a resistive voltage-divider between the step-down regulator output (OUT) and GND to set the step-down regulator output voltage. Place the resistive voltage-divider within 5mm of FB2.
11	OUT	Step-Down Regulator Output Voltage Sense. Connect OUT to step-down regulator output.
12	N.C.	Not Connected
13, 14	LX2	Step-Down Regulator Switching Node. LX2 is the source of the internal n-channel MOSFET connected between IN2 and LX2. Connect the inductor and Schottky catch diode to both LX2 pins and minimize the trace area for lowest EMI.
15	BST	Step-Down Regulator Bootstrap Capacitor Connection. Power supply for high-side gate driver. Connect a 0.1 μ F ceramic capacitor from BST to LX2.
16, 17	IN2	Step-Down Regulator Power Input. Drain of the internal n-channel MOSFET connected between IN2 and LX2.
18, 44	GND	Analog Ground
19	VDET	Voltage-Detector Input. Connects VDET to the center of a resistor voltage-divider between input voltage and GND to set the trigger point of XAO.
20	INVL	Internal 5V Linear Regulator and the Startup Circuitry Power Supply. Bypass VINVL to GND with 0.22 μ F close to the IC.
21	VL	5V Internal Linear Regulator Output. Bypass VL to GND with 1 μ F minimum. Provides power for the internal MOSFET driving circuit, the PWM controllers, charge-pump regulators, logic, and reference and other analog circuitry. Provides 25mA load current when all switching regulators are enabled. VL is active whenever input voltage is high enough.
22	FSEL	Frequency Select Pin. Connect FSEL to VL or INVL or disconnect FSEL pin for 750kHz operation. Connect to GND for 500kHz operation.
23	CLIM	Boost Current-Limit Setting Input. Connects a resistor from CLIM to GND to set current limit for boost converter.
24	SS	Soft-Start Input. Connects a capacitor from SS to GND to set the soft-start time for the step-up converter. A 5 μ A current source starts to charge C _{SS} when GD is done. See the <i>Step-Up Regulator External pMOS Pass Switch</i> section for description. SS is internally pulled to GND through 1k Ω resistance when EN is low OR when VL is below its UVLO threshold.
25, 26	LX1	Step-Up Regulator Power-MOSFET n-Channel Drain and Switching Node. Connects the inductor and Schottky catch diode to both LX1 pins and minimizes the trace area for lowest EMI.
27, 28	PGND	Step-Up Regulator Power Ground
29	GD_I	Step-Up Regulator External pMOS Pass Switch Source Input. Connects to the cathode of the step-up regulator Schottky catch diode.

MAX17126B

Multi-Output Power Supplies with VCOM Amplifier and High-Voltage Gamma Reference for LCD TVs

Pin Description (continued)

PIN	NAME	FUNCTION
30	GD	Step-Up Regulator External pMOS Pass Switch Gate Input. A $10\mu\text{A} \leq 20\%$ current source pulls down on the gate of the external pFET when EN is high.
31	FB1	Boost Regulator Feedback Input. Connects FB1 to the center of a resistive voltage-divider between the boost regulator output and GND to set the boost regulator output voltage. Place the resistive voltage-divider within 5mm of FB1.
32	COMP	Compensation Pin for the Step-Up Regulator Error Amplifier. Connects a series resistor and capacitor from COMP to ground.
33	THR	VGHM Low-Level Regulation Set-Point Input. Connects THR to the center of a resistive voltage-divider between AVDD and GND to set the VGHM falling regulation level. The actual level is $10 \times V_{THR}$. See the <i>Switch Control</i> section for details.
34	SUPP	Positive Charge-Pump Drivers Power Supply. Connects to the output of the boost regulator (AVDD) and bypasses to CPGND with a $0.1\mu\text{F}$ capacitor. SUPP is internally connected to GD_I.
35	CPGND	Charge Pump and Buck Power Ground
36	DRVP	Positive Charge-Pump Driver Output. Connects DRVP to the positive charge-pump flying capacitor(s).
37	DLY1	High-Voltage Switch Array Delay Input. Connects a capacitor from DLY1 to GND to set the delay time between when the positive charge pump finishes its soft-start and the startup of this high-voltage switch array. A $10\mu\text{A}$ current source charges C_{DLY1} . DLY1 is internally pulled to GND through 50Ω resistance when EN is low or when VL is below its UVLO threshold.
38	FBP	Positive Charge-Pump Regulator Feedback Input. Connects FBP to the center of a resistive voltage-divider between the positive charge-pump regulator output and GND to set the positive charge-pump regulator output voltage. Place the resistive voltage-divider within 5mm of FBP.
39	VGH	Switch Input. Source of the internal high-voltage p-channel MOSFET between VGH and VGHM.
40	VGHM	Internal High-Voltage MOSFET Switch Common Terminal. VGHM is the output of the high-voltage switch-control block.
41	DRN	Switch Output. Drain of the internal high-voltage p-channel MOSFET connected to VGHM.
42	SUPN	Negative Charge-Pump Drivers Power Supply. Bypass to CPGND with a $0.1\mu\text{F}$ capacitor. SUPN is internally connected to IN2.
43	DRVN	Negative Charge-Pump Driver Output. Connects DRVN to the negative charge-pump flying capacitor(s).
45	FBN	Negative Charge-Pump Regulator Feedback Input. Connect FBN to the center of a resistive voltage-divider between the negative output and REF to set the negative charge-pump regulator output voltage. Place the resistive voltage-divider within 5mm of FBN.
46	REF	Reference Output. Connects a $0.22\mu\text{F}$ capacitor from REF to GND. All power outputs are disabled until REF exceeds its UVLO threshold.
47	VREF_FB	Gamma Reference Feedback Input. Connect VREF_FB to the center of a resistive voltage-divider between VREF_O and GND to set the gamma reference output voltage. Place the resistive voltage-divider within 5mm of VREF_FB.
48	VREF_O	Gamma Reference Output
—	EP	Exposed Pad. Connects EP to GND, and ties EP to a copper plane or island. Maximizes the area of this copper plane or island to improve thermal performance.

MAX17126B

Multi-Output Power Supplies with VCOM Amplifier and High-Voltage Gamma Reference for LCD TVs

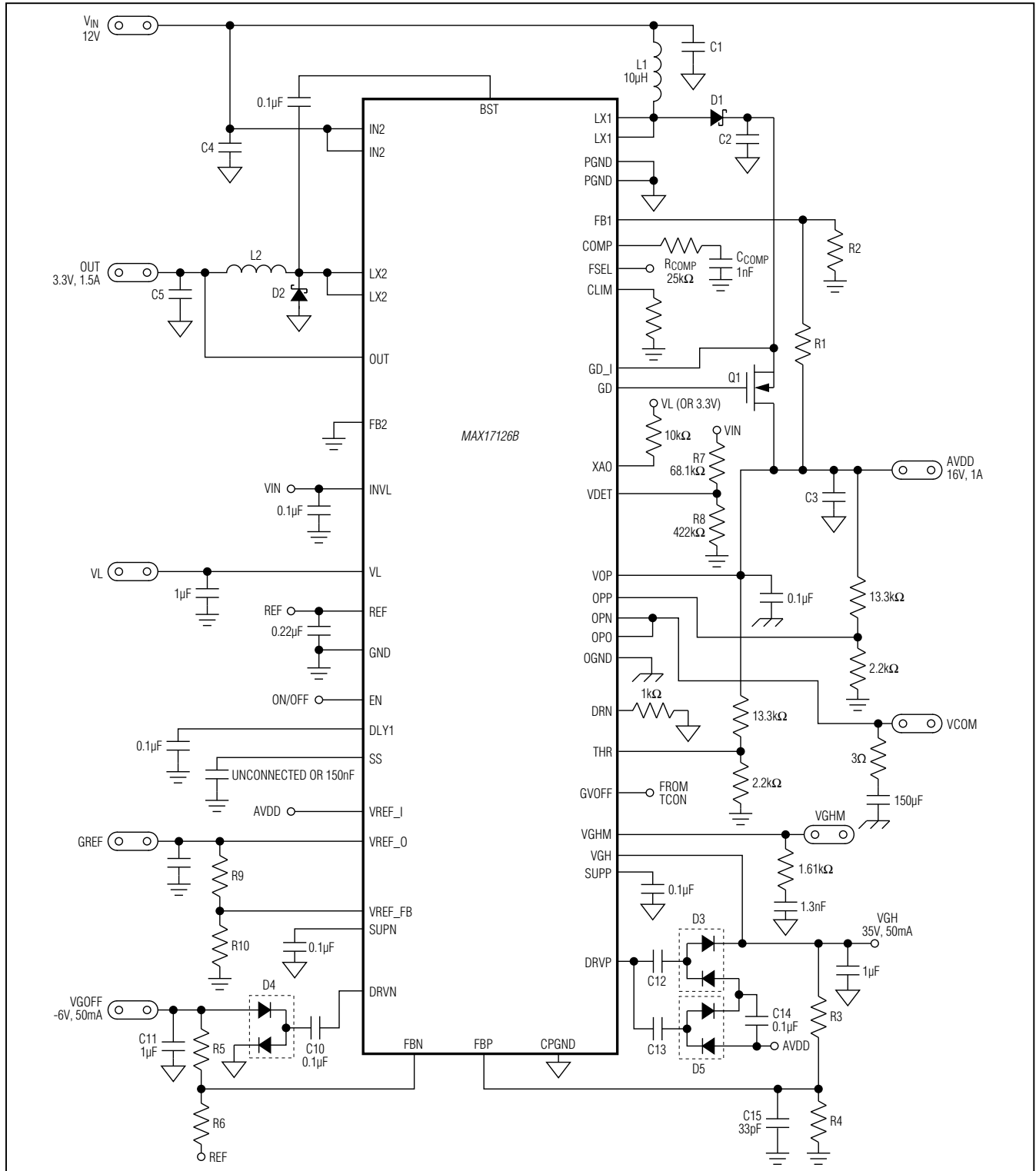


Figure 1. Typical Operating Circuit

MAX17126B

Multi-Output Power Supplies with VCOM Amplifier and High-Voltage Gamma Reference for LCD TVs

Typical Operating Circuit

The typical operating circuit (Figure 1) of the device comprises a complete power-supply system for TFT LCD TV panels. The circuit generates a +3.3V logic supply, a +16V source driver supply, a +35V positive gate-driver supply, a -6V negative gate-driver supply, and a $\leq 0.5\%$ high-accuracy, high-voltage gamma reference. Table 1 lists some selected components and Table 2 lists the contact information for component suppliers.

Table 1. Component List

DESIGNATION	DESCRIPTION
C1–C4	10 μ F $\leq \pm 10\%$, 25V X5R ceramic capacitors (1206) Murata GRM31CR61E106K TDK C3216X5R1E106M
C5	22 μ F $\pm 10\%$, 6.3V X5R ceramic capacitor (0805) Murata GRM21BR60J226K TDK C2012X5R0J226K
D1, D2	Schottky diodes 30V, 3A (M-flat) Toshiba CMS02
D3, D4, D5	Dual diodes 30V, 200mA (3 SOT23) Zetex BAT54S Fairchild BAT54S
L1	Inductor, 10 μ H, 3A, 45m Ω inductor (8.3mm x 9.5mm x 3mm) Coiltronics SD8328-100-R Sumida CDRH8D38NP-100N (8.3mm x 8.3mm x 4mm)
L2	Inductor, 4.7 μ H, 3A, 24.7m Ω inductor (8.3mm x 9.5mm x 3mm) Coiltronics SD8328-4R7-R Sumida CDRH8D38NP-4R7N (8.3mm x 8.3mm x 4mm)

Detailed Description

The MAX17126B is a multiple-output power supply designed primarily for TFT LCD TV panels. It contains a step-down switching regulator to generate the supply for system logic, a step-up switching regulator to generate the supply for source driver, and two charge-pump regulators to generate the supplies for TFT gate drivers, a high-accuracy, high-voltage reference supply for gamma correction. Each regulator features adjustable output voltage, digital soft-start, and timer-delayed fault protection. Both the step-down and step-up regulators use fixed-frequency current-mode control architecture. The two switching regulators are 180° out of phase to minimize the input ripple. The internal oscillator offers two pin-selectable frequency options (500kHz/750kHz), allowing users to optimize their designs based on the specific application requirements. The step-up regulator also features adjustable current limit that can be adjusted through a resistor at the CLIM pin. The device includes one high-performance operational amplifier designed to drive the LCD backplane (VCOM). The amplifier features high-output current (≤ 200 mA), fast slew rate (45V/ μ s), wide bandwidth (20MHz), and rail-to-rail outputs. The high-accuracy, high-voltage gamma reference has its error controlled to within $\leq 0.5\%$ and can deliver more than 60mA current. In addition, the device features a high-voltage switch-control block, an internal 5V linear regulator, a 1.25V reference output, well-defined power-up and power-down sequences, and fault and thermal-overload protection. Figure 2 shows the device functional diagram.

Table 2. Operating Mode

SUPPLIER	PHONE	FAX	WEBSITE
Fairchild Semiconductor	408-822-2000	408-822-2102	www.fairchildsemi.com
Sumida Corp.	847-545-6700	847-545-6720	www.sumida.com
TDK Corp.	847-803-6100	847-390-4405	www.component.tdk.com
Toshiba America Electronic Components, Inc.	949-455-2000	949-859-3963	www.toshiba.com/taec

MAX17126B

Multi-Output Power Supplies with VCOM Amplifier and High-Voltage Gamma Reference for LCD TVs

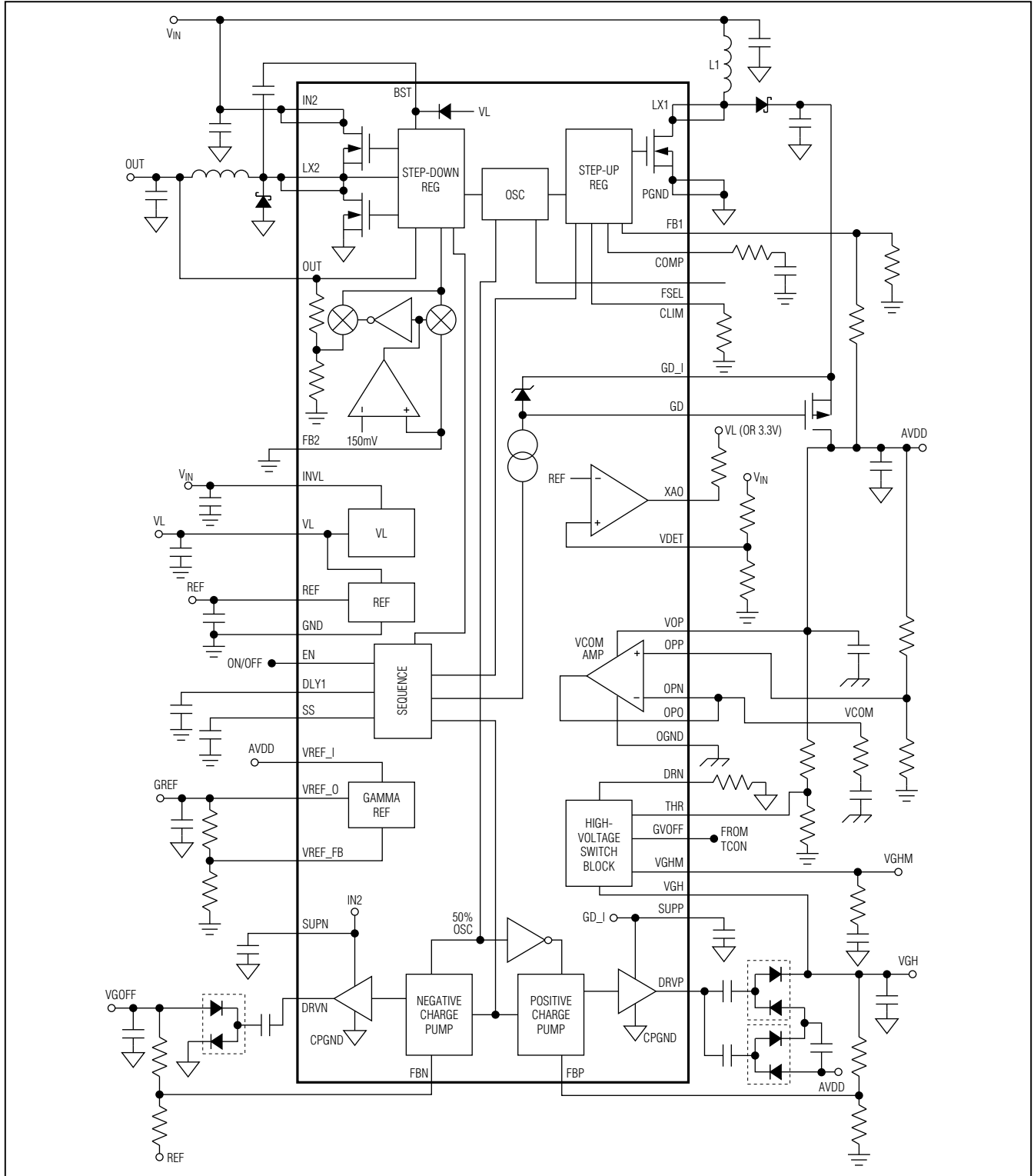


Figure 2. Functional Diagram

Multi-Output Power Supplies with VCOM Amplifier and High-Voltage Gamma Reference for LCD TVs

Step-Down Regulator

The step-down regulator consists of an internal n-channel MOSFET with gate driver, a lossless current-sense network, a current-limit comparator, and a PWM controller block. The external power stage consists of a Schottky diode rectifier, an inductor, and output capacitors. The output voltage is regulated by changing the duty cycle of the high-side MOSFET. A bootstrap circuit that uses a 0.1µF flying capacitor between LX2 and BST provides the supply voltage for the high-side gate driver. Although the device also includes a 10Ω (typ) low-side MOSFET, this switch is used to charge the bootstrap capacitor during startup and maintains fixed-frequency operation at light load and cannot be used as a synchronous rectifier. An external Schottky diode (D2 in Figure 1) is always required.

PWM Controller Block

The heart of the PWM control block is a multi-input, open-loop comparator that sums three signals: the output-voltage signal with respect to the reference voltage, the current-sense signal, and the slope-compensation signal. The PWM controller is a direct-summing type, lacking a traditional error amplifier and the phase shift associated with it. This direct-summing configuration approaches ideal cycle-by-cycle control over the output voltage.

The step-down controller always operates in fixed-frequency PWM mode. Each pulse from the oscillator sets the main PWM latch that turns on the high-side switch until the PWM comparator changes state. As the high-side switch turns off, the low-side switch turns on. The low-side switch stays on until the beginning of the next clock cycle.

Current Limiting and Lossless Current Sensing

The current-limit circuit turns off the high-side MOSFET switch whenever the voltage across the high-side MOSFET exceeds an internal threshold.

For current-mode control, an internal lossless sense network derives a current-sense signal from the inductor DCR. The time constant of the current-sense network is not required to match the time constant of the inductor and has been chosen to provide sufficient current ramp signal for stable operation at both operating frequencies. The current-sense signal is AC-coupled into the PWM comparator, eliminating most DC output-voltage variation with load current.

Dual-Mode Feedback

The step-down regulator of the device supports both fixed output and adjustable output. Connect FB2 to GND to enable the 3.3V fixed-output voltage. Connect a resistive voltage-divider between OUT and GND with the center tap connected to FB2 to adjust the output voltage.

Choose RB (resistance from FB2 to GND) to be between 5kΩ and 50kΩ, and solve for RA (resistance from OUT to FB2) using the equation:

$$RA = RB \times \left(\frac{V_{OUT}}{V_{FB2}} - 1 \right)$$

where $V_{FB2} = 1.25V$, and V_{OUT} may vary from 1.5V to 5V.

Because FB2 is a very sensitive pin, a noise filter is generally required for FB2 in adjustable-mode operation. Place an 82pF capacitor from FB2 to GND to prevent unstable operation. No filter is required for 3.3V fixed-mode operation.

Soft-Start

The step-down regulator includes a 7-bit soft-start DAC that steps its internal reference voltage from zero to 1.25V in 128 steps. The soft-start period is 3ms (typ) and FB2 fault detection is disabled during this period. The soft-start feature effectively limits the inrush current during startup (see the Step-Down Regulator Soft-Start Waveforms in the *Typical Operating Characteristics*).

Step-Up Regulator

The step-up regulator employs a current-mode, fixed-frequency PWM architecture to maximize loop bandwidth and provide fast-transient response to pulsed loads typical of TFT LCD panel source drivers. The integrated MOSFET and the built-in digital soft-start function reduce the number of external components required while controlling inrush currents. The output voltage can be set from V_{IN} to 16.5V with an external resistive voltage-divider. The regulator controls the output voltage and the power delivered to the output by modulating duty cycle D of the internal power MOSFET in each switching cycle. The duty cycle of the MOSFET is approximated by:

$$D \approx \frac{V_{AVDD} + V_{DIODE} - V_{IN}}{V_{AVDD} + V_{DIODE} - V_{LX1}}$$

where V_{AVDD} is the output voltage of the step-up regulator, V_{DIODE} is the voltage drop across the diode, and V_{LX1} is the voltage drop across the internal MOSFET.

PWM Controller Block

An error amplifier compares the signal at FB1 to 1.25V and changes the COMP output. The voltage at COMP sets the peak inductor current. As the load varies, the error amplifier sources or sinks current to the COMP output accordingly to produce the inductor peak current necessary to service the load. To maintain stability at high duty cycles, a slope compensation signal is summed with the current-sense signal.

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On the rising edge of the internal clock, the controller sets a flip-flop, turning on the n-channel MOSFET and applying the input voltage across the inductor. The current through the inductor ramps up linearly, storing energy in its magnetic field. Once the sum of the current-feedback signal and the slope compensation exceed the COMP voltage, the controller resets the flip-flop and turns off the MOSFET. Since the inductor current is continuous, a transverse potential develops across the inductor that turns on diode D1. The voltage across the inductor then becomes the difference between the output voltage and the input voltage. This discharge condition forces the current through the inductor to ramp back down, transferring the energy stored in the magnetic field to the output capacitor and the load. The MOSFET remains off for the rest of the clock cycle.

Step-Up Regulator External pMOS Pass Switch

As shown in Figure 1, a series external p-channel MOSFET can be installed between the cathode of the step-up regulator Schottky catch diode and the V_{AVDD} filter capacitors. This feature is used to sequence power to AVDD after the device has proceeded through normal startup to limit input surge current during the output capacitor initial charge, and to provide true shutdown when the step-up regulator is disabled. When EN is low, GD is internally pulled up to the GD_I through a 25 Ω resistor. Once EN is high and the negative charge-pump regulator is in regulation, the GD starts pulling down with a 10 μ A (typ) internal current source. The external p-channel MOSFET turns on and connects the cathode of the step-up regulator Schottky catch diode to the step-up regulator load capacitors when GD falls below the turn-on

threshold of the MOSFET. When V_{GD} reaches $V_{GD_I} - 6V$ (GD done), the step-up regulator is enabled and initiates a soft-start routine.

When not using this feature, leave GD high impedance, and connect GD_I to the output of the step-up converter.

Soft-Start

The step-up regulator achieves soft-start by linearly ramping up its internal current limit. The soft-start is either done internally when the capacitance on pin SS is < 200pF or externally when capacitance on pin SS is > 200pF. The internal soft-start ramps up the current limit in 128 steps in 12ms. The external soft-start terminates when the SS pin voltage reaches 1.25V. The soft-start feature effectively limits the inrush current during startup (see the Step-Up Regulator Soft-Start Waveforms in the *Typical Operating Characteristics*).

Positive Charge-Pump Regulator

The positive charge-pump regulator (Figure 3) is typically used to generate the positive supply rail for the TFT LCD gate driver ICs. The output voltage is set with an external resistive voltage-divider from its output to GND with the midpoint connected to FBP. The number of charge-pump stages and the setting of the feedback divider determine the output voltage of the positive charge-pump regulator. The charge pump includes a high-side p-channel MOSFET (P1) and a low-side n-channel MOSFET (N1) to control the power transfer as shown in Figure 3.

During the first half cycle, N1 turns on and charges flying capacitors C12 and C13 (Figure 3). During the second half cycle, N1 turns off and P1 turns on, level shifting C12 and C13 by V_{SUPP} volts. If the voltage across C15 (V_{GH})

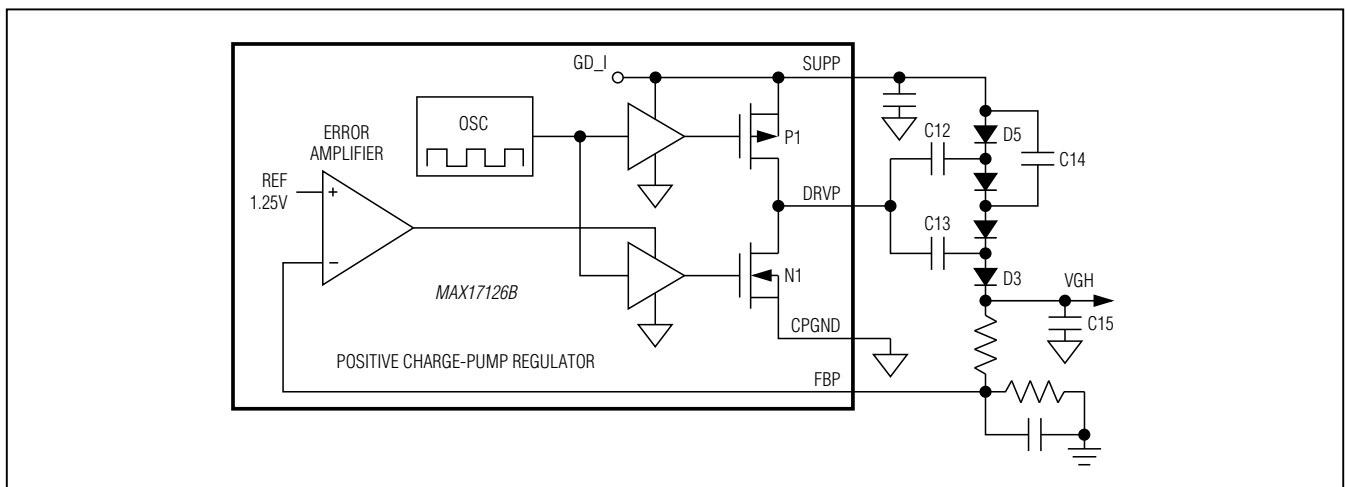


Figure 3. Positive Charge-Pump Regulator Block Diagram

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plus a diode drop (V_D) is smaller than the level-shifted flying-capacitor voltage (V_{C13}) plus V_{SUPP} , charge flows from C13 to C15 until the diode (D3) turns off. The amount of charge transferred to the output is determined by the error amplifier that controls N1's on-resistance.

Each time it is enabled, the positive charge-pump regulator goes through a soft-start routine by ramping up its internal reference voltage from 0 to 1.25V in 128 steps. The soft-start period is 2ms (typ) and FBP fault detection is disabled during this period. The soft-start feature effectively limits the inrush current during startup.

Negative Charge-Pump Regulator

The negative charge-pump regulator is typically used to generate the negative supply rail for the TFT LCD gate driver ICs. The output voltage is set with an external resistive voltage-divider from its output to REF with the midpoint connected to FBN. The number of charge-pump stages and the setting of the feedback divider determine the output of the negative charge-pump regulator. The charge-pump controller includes a high-side p-channel

MOSFET (P2) and a low-side n-channel MOSFET (N2) to control the power transfer as shown in Figure 4.

During the first half cycle, P2 turns on, and flying capacitor C10 charges to V_{SUPN} minus a diode drop (Figure 4). During the second half cycle, P2 turns off, and N2 turns on, level shifting C10. This connects C10 in parallel with reservoir capacitor C11. If the voltage across C11 minus a diode drop is greater than the voltage across C10, charge flows from C11 to C10 until the diode (D4) turns off. The amount of charge transferred from the output is determined by the error amplifier that controls N2's on-resistance.

The negative charge-pump regulator is enabled after the step-down regulator finishes soft-start. Each time it is enabled, the negative charge-pump regulator goes through a soft-start routine by ramping down its internal reference voltage from 1.25V to 250mV in 128 steps. The soft-start period is 1.8ms (typ) and FBN fault detection is disabled during this period. The soft-start feature effectively limits the inrush current during startup.

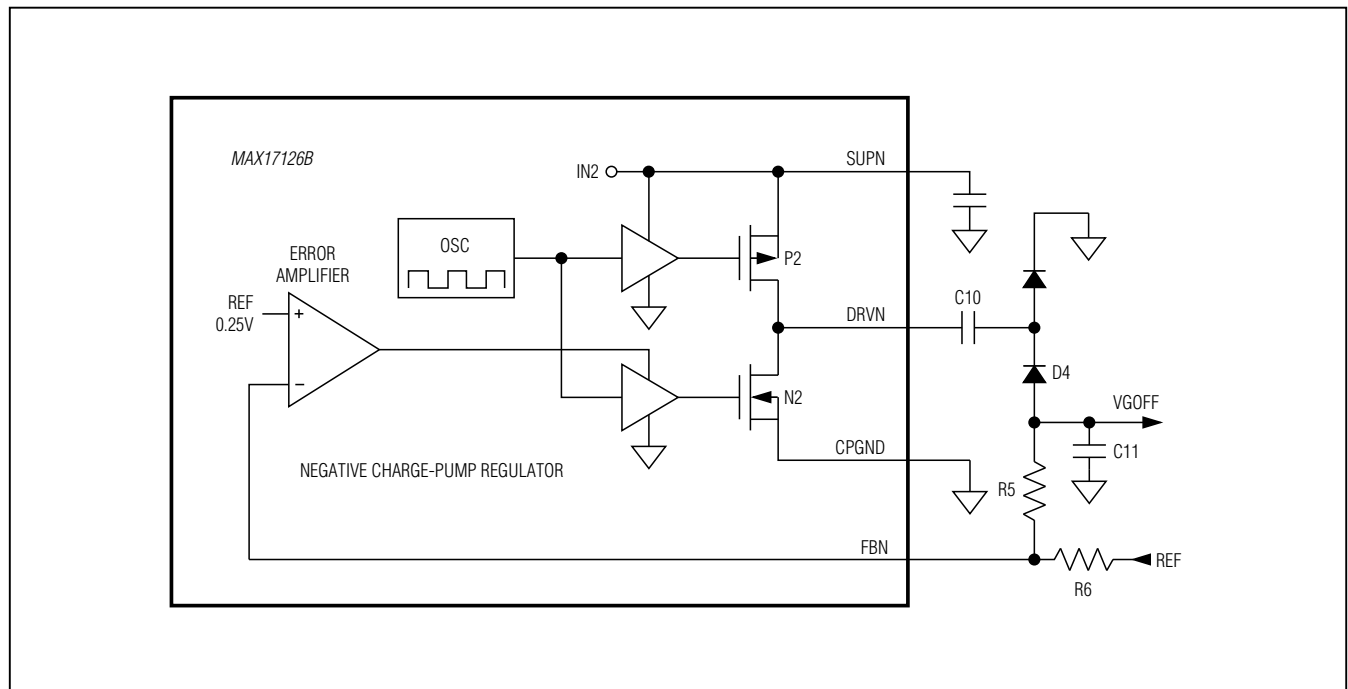


Figure 4. Negative Charge-Pump Regulator Block Diagram

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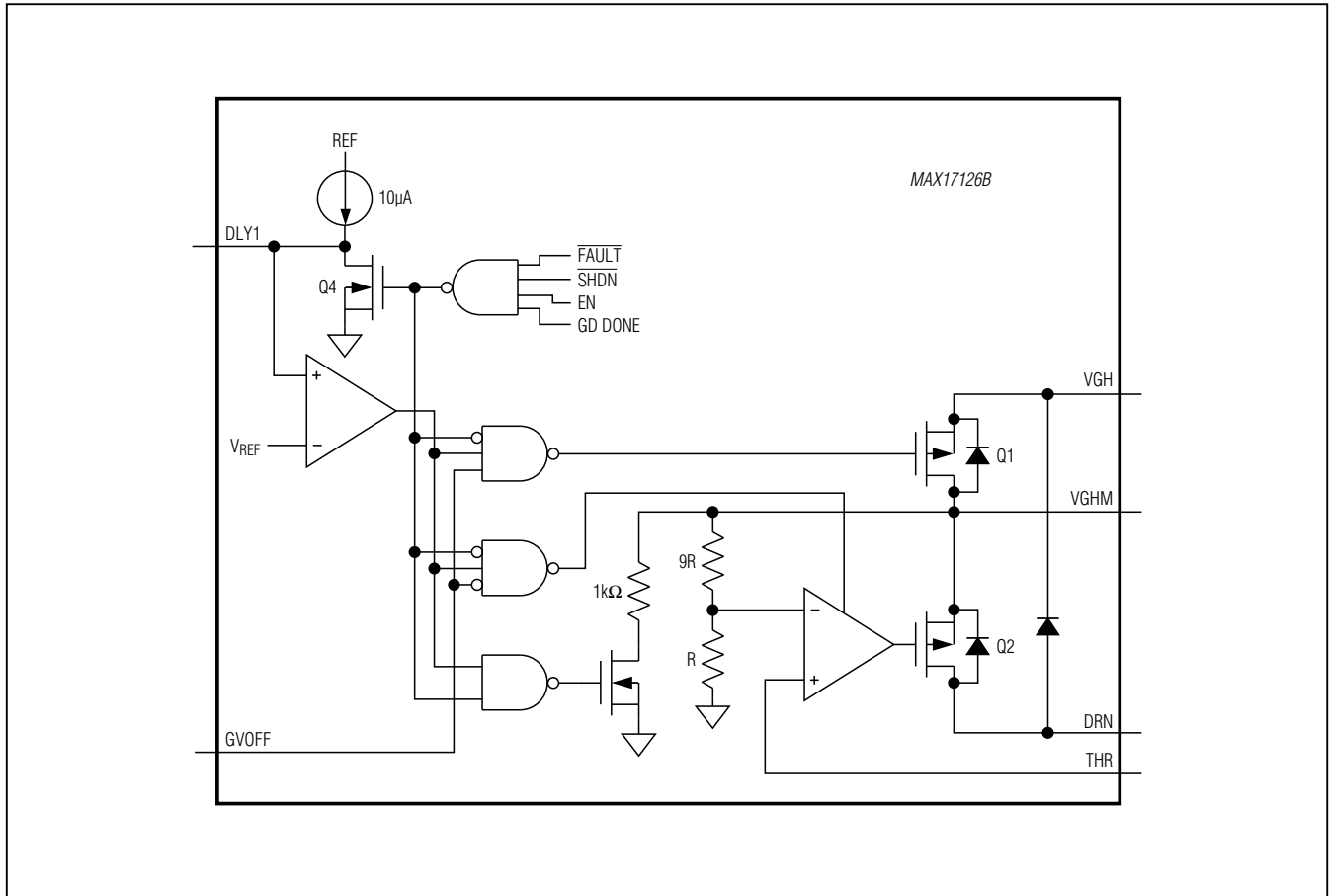


Figure 5. Switch Control

High-Voltage Switch Control

The device's high-voltage switch control block (Figure 5) consists of two high-voltage p-channel MOSFETs: Q1, between VGH, and VGHM and Q2, between VGHM and DRN. The switch control block is enabled when V_{DLY1} exceeds V_{REF} . Q1 and Q2 are controlled by GVOFF.

When GVOFF is logic-high, Q1 turns on and Q2 turns off, connecting VGHM to VGH. When GVOFF is logic-low, Q1 turns off and Q2 turns on, connecting VGHM to DRN. VGHM can then be discharged through a resistor connected between DRN and GND or AVDD. Q2 turns

off and stops discharging VGHM when VGHM reaches 10 times the voltage on THR.

The switch control block is disabled and DLY1 is held low when the LCD is shut down or in a fault state.

Operational Amplifier

The operational amplifier is typically used to drive the LCD backplane (VCOM). It features $\pm 200\text{mA}$ output short-circuit current, $45\text{V}/\mu\text{s}$ slew rate, and $20\text{MHz}/3\text{dB}$ bandwidth. The rail-to-rail input and output capability maximizes system flexibility.

MAX17126B

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Short-Circuit Current Limit and Input Clamp

The operational amplifier limits short-circuit current to approximately $\pm 200\text{mA}$ if the output is directly shorted to VOP or to OGND. If the short-circuit condition persists, the junction temperature of the IC rises until it reaches the thermal-shutdown threshold ($+160^\circ\text{C}$ typ). Once the junction temperature reaches the thermal-shutdown threshold, an internal thermal sensor immediately sets the thermal fault latch, shutting off all the IC's outputs. The device remains inactive until the input voltage is cycled. The operational amplifiers have 4V input clamp structures in series with a 500Ω resistance and a diode (Figure 6).

Driving Pure Capacitive Load

The LCD backplane consists of a distributed series capacitance and resistance, a load that can be easily driven by the operational amplifier. However, if the operational amplifier is used in an application with a pure capacitive load, steps must be taken to ensure stable operation. As the operational amplifier's capacitive load increases, the amplifier's bandwidth decreases and gain peaking increases. A 5Ω to 50Ω small resistor placed between OPO and the capacitive load reduces peaking, but also reduces the gain. An alternative method of reducing peaking is to place a series RC network (snubber) in parallel with the capacitive load. The RC network does not continuously load the output or reduce the gain. Typical values of the resistor are between 100Ω and 200Ω , and the typical value of the capacitor is 10nF .

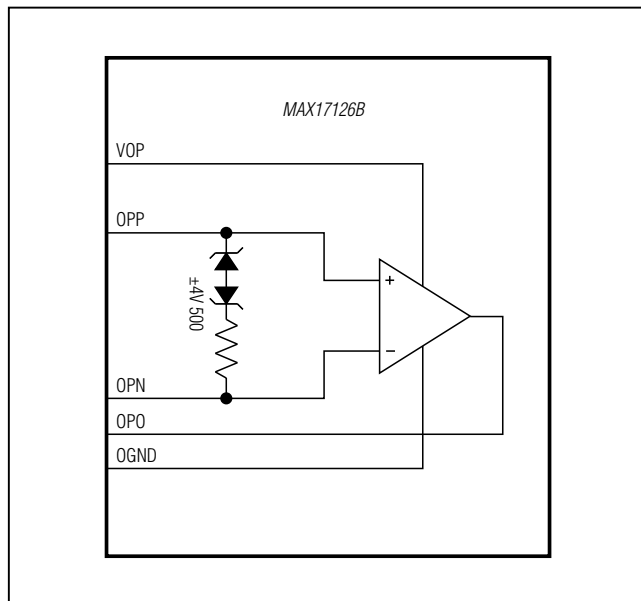


Figure 6. Op Amp Input Clamp Structure

Linear Regulator (VL)

The device includes an internal linear regulator. INVL is the input of the linear regulator. The input voltage range is between 8V and 16.5V. The output voltage is set to 5V. The regulator powers the internal MOSFET drivers, PWM controllers, charge-pump regulators, and logic circuitry. The total external load capability is 25mA. Bypass VL to GND with a minimum $1\mu\text{F}$ ceramic capacitor.

Reference Voltage (REF)

The reference output is nominally 1.25V, and can source at least $50\mu\text{A}$ (see *Typical Operating Characteristics*). VL is the input of the internal reference block. Bypass REF with a $0.22\mu\text{F}$ ceramic capacitor connected between REF and GND.

High-Accuracy, High-Voltage Gamma Reference

The LDO is typically used to drive gamma-correction divider string. Its output voltage is adjustable through a resistor-divider. This LDO features high output accuracy ($\pm 0.5\%$) and low-dropout voltage (0.25V typ) and can supply at least 60mA.

XAO Function

XAO is an open-drain output that connects to GND when VDET is below its detection threshold (1.25V typ). In the meantime, VGHM is tied to VGH. XAO is guaranteed to remain low until VGH is above 6.6V and VL > 2.5V.

Frequency Selection and Out-of-Phase Operation (FSEL)

The step-down regulator and step-up regulator use the same internal oscillator. The FSEL input selects the switching frequency. Table 3 shows the switching frequency based on the FSEL connection. High-frequency (750kHz) operation optimizes the application for the smallest component size, trading off efficiency due to higher switching losses. Low-frequency (500kHz) operation offers the best overall efficiency at the expense of component size and board space.

To reduce the input RMS current, the step-down regulator and the step-up regulator operate 180° out of phase from each other. The feature allows the use of less input capacitance.

Table 3. Frequency Selection

FSEL	SWITCHING FREQUENCY (kHz)
VL, INVL, or unconnected	750
GND	500